

SV-SMT 7.62IT/04/90MF4 2.6SN BK RL SO**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Similar to illustration

**OMNIMATE Power for IT networks – scalable to 50 kVA****Tailor-made solutions for special requirements**

More standard-compliance means fewer compromises: OMNIMATE Power for IT networks has integrated features incorporated as standard across the range. This makes the design-in and approvals process simpler and makes them safer and more reliable in operation.

Results for the application and advantages for the user: unlimited use in 400-V IT systems and touch safety according to IEC 61800-5-1 (+ 5.5 mm). The self-snapping one-handed safety flange enables intuitive and safe usage. Operational reliability is guaranteed by the automatic interlock feature during the plug-in process. In conclusion: You need no additional device covering. The application-oriented design means that no compromises are necessary during the approval process.

General ordering data

Version	PCB plug-in connector, male header, Middle flange, THT/THR solder connection, 7.62 mm, Number of poles: 4, 90°, Solder pin length (l): 2.6 mm, tinned, black, Tape
Order No.	2454160000
Type	SV-SMT 7.62IT/04/90MF4 2.6SN BK RL SO
GTIN (EAN)	4050118468762
Qty.	110 pc(s).
Product data	IEC: 1000 V / 41 A UL: 300 V / 40.5 A
Packaging	Tape

SV-SMT 7.62IT/04/90MF4 2.6SN BK RL SO

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Technical data

Dimensions and weights

Depth	28.3 mm	Depth (inches)	1.114 inch
Height of lowest version	11.4 mm	Net weight	8.33 g

System specifications

Product family	OMNIMATE Power - series BV/SV 7.62HP	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	7.62 mm
Pitch in inches (P)	0.3 inch	Outgoing elbow	90°
Number of poles	4	Number of solder pins per pole	2
Solder pin length (l)	2.6 mm	Solder pin length tolerance	+0.1 / -0.3 mm
Solder pin dimensions	0.8 x 1.0 mm	Solder eyelet hole diameter (D)	1.4 mm
Solder eyelet hole diameter tolerance (D)+ 0.1 mm		L1 in mm	30.48 mm
L1 in inches	1.2 inch	Number of rows	1
Pin series quantity	1	Touch-safe protection acc. to DIN VDE 57 106	safe to back of hand above the printed circuit board
Touch-safe protection acc. to DIN VDE 0470	IP 20	Volume resistance	2.00 mΩ
Plugging cycles	25	Plugging force/pole, max.	12 N
Pulling force/pole, max.	7 N		

Material data

Insulating material	PA GF HT3	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	I
Comparative Tracking Index (CTI)	≥ 600	Insulation strength	≥ 10 ⁸ Ω
Moisture Level (MSL)	3	UL 94 flammability rating	V-0
Contact material	Copper alloy	Contact surface	tinned
Layer structure of solder connection	1...3 μm Ni / 4...6 μm Sn matt	Layer structure of plug contact	1...3 μm Ni / 4...6 μm Sn matt
Storage temperature, min.	-40 °C	Storage temperature, max.	70 °C
Operating temperature, min.	-50 °C	Operating temperature, max.	130 °C
Temperature range, installation, min.	-25 °C	Temperature range, installation, max.	130 °C

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	41 A
Rated current, max. number of poles (Tu=20°C)	41 A	Rated current, min. number of poles (Tu=40°C)	41 A
Rated current, max. number of poles (Tu=40°C)	41 A	Rated voltage for surge voltage class / pollution degree II/2	1,000 V
Rated voltage for surge voltage class / pollution degree III/2	630 V	Rated voltage for surge voltage class / pollution degree III/3	630 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	6 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	6 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	6 kV	Short-time withstand current resistance	3 x 1s with 420 A

SV-SMT 7.62IT/04/90MF4 2.6SN BK RL SO

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Technical data

Rated data acc. to UL 1059

Institute (cURus)



Certificate No. (cURus)

E60693

Rated voltage (Use group B / UL 1059) 300 V

Rated voltage (Use group D / UL 1059) 300 V

Rated current (Use group C / UL 1059) 40.5 A

Clearance distance, min. 6.9 mm

Reference to approval values
Specifications are maximum values, details - see approval certificate.

Rated voltage (Use group C / UL 1059) 300 V

Rated current (Use group B / UL 1059) 40.5 A

Rated current (Use group D / UL 1059) 10 A

Creepage distance, min. 9.6 mm

Packing

Packaging	Tape	VPE length	0 mm
VPE width	0 mm	VPE height	0 mm
Tape depth (T2)	15.8 mm	Tape width (W)	56 mm
Tape pocket depth (K0)	15.3 mm	Tape pocket height (A0)	28.4 mm
Tape pocket width (B0)	39.06 mm	Tape pocket separation (P1)	36 mm
Tape hole separation (E)	1.75 mm	Tape pocket separation (F)	26.2 mm
Tape reel diameter $\varnothing$ (A)	330 mm	Surface resistance	$R_s = 10^9 - 10^{12} \Omega$

Classifications

ETIM 6.0	EC002638	ETIM 7.0	EC002638
ECLASS 9.0	27-44-03-09	ECLASS 9.1	27-44-03-09
ECLASS 10.0	27-44-03-09	ECLASS 11.0	27-46-02-02

Important note

IPC conformity Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- Additional colours on request
- Rated current related to rated cross-section & min. No. of poles.
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

Approvals

Approvals



UL File Number Search

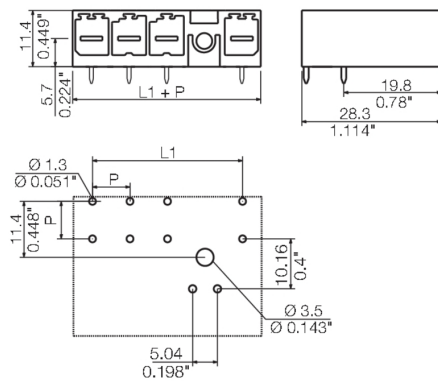
E60693

SV-SMT 7.62IT/04/90MF4 2.6SN BK RL SO

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 26
D-32758 Detmold
Germany

www.weidmueller.com

Drawings



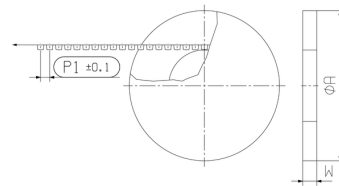
SV-SMT 7.62IT/04/90MF4 2.6SN BK RL SO

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 26
D-32758 Detmold
Germany

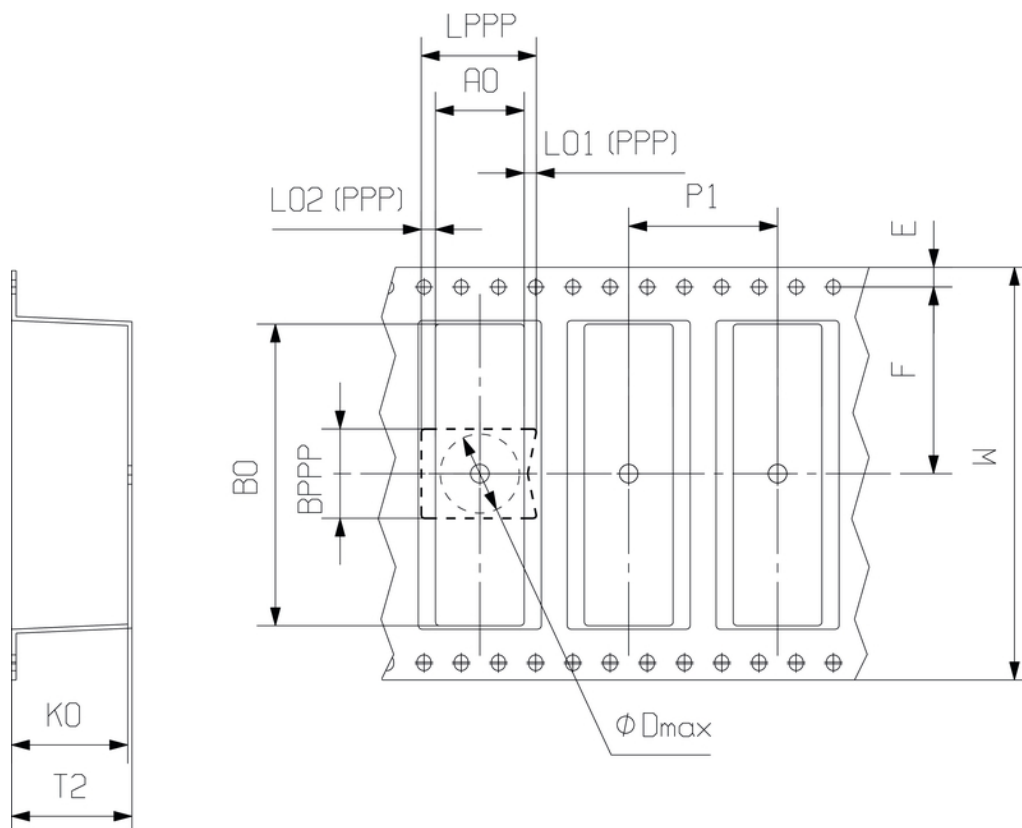
www.weidmueller.com

Drawings

Dimensional drawing



Dimensional drawing



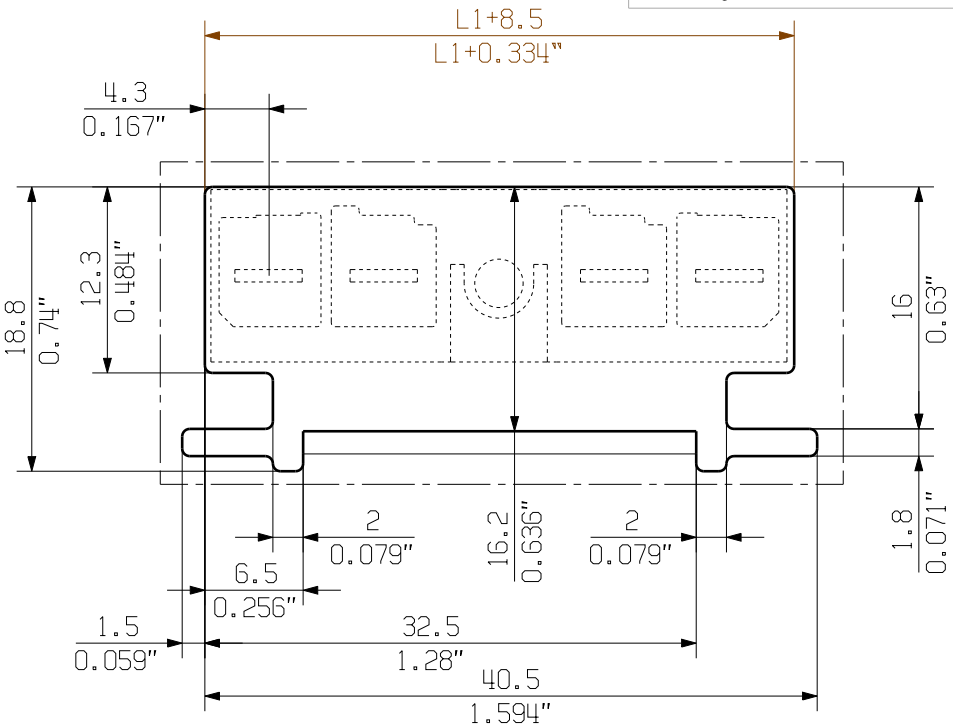
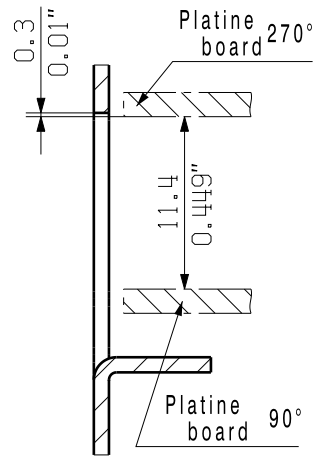
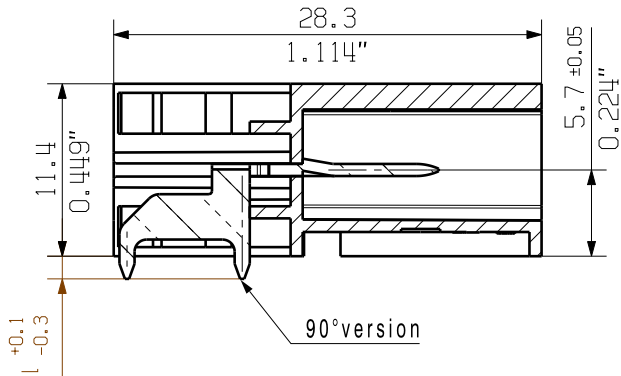
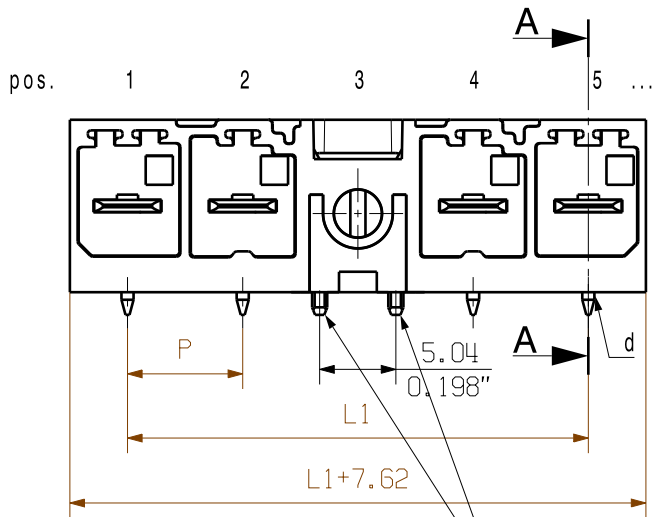
The reproduction, distribution and utilization of this document as well as the communication of its contents to others without explicit authorization is prohibited. Offenders will be held liable for the payment of damages. Weidmüller exclusively reserves the right to file for patents, utility models or designs.

© Weidmüller Interface GmbH & Co. KG

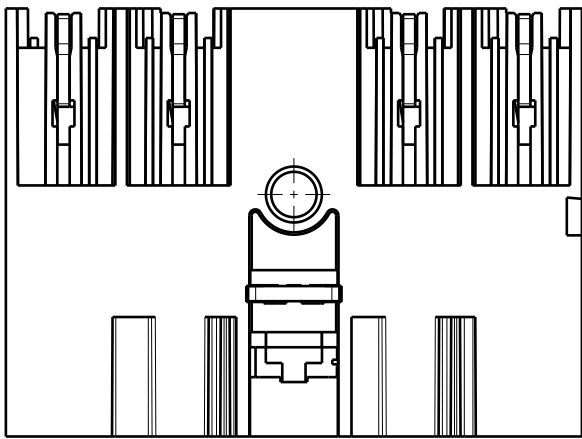
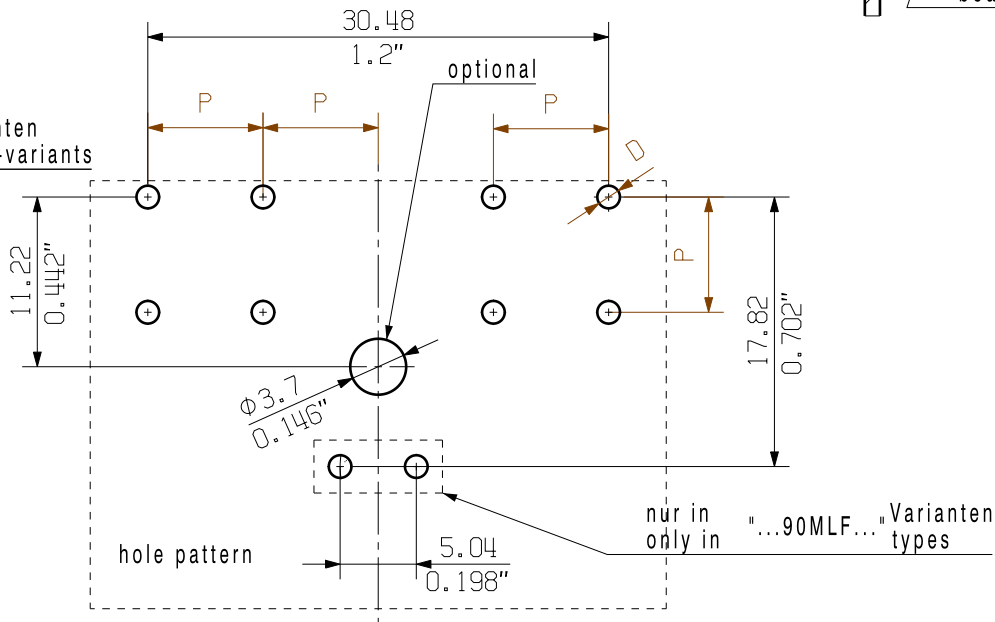
Dimensions without tolerances are no check dimensions

The English version is binding

SV-SMT 7.62IT/04/90M(L)F3



Lötstifte nur für MLF-Varianten
Soldering pins only for MLF-variants



POL = Pol/pole
PE = PE= Voreilender Kontakt / leading pin

P = Raster / pitch 7.62

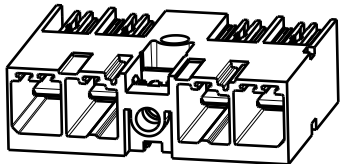
MF= Mittelflansch
middle flange

MSF= Mittelschraubflansch
middle flange with screw

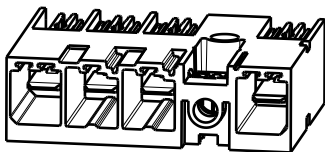
MLF= Mittellötflansch
middle solder flange

D = Ø1.5+0.1/-0.05
d = 0.8x1.0

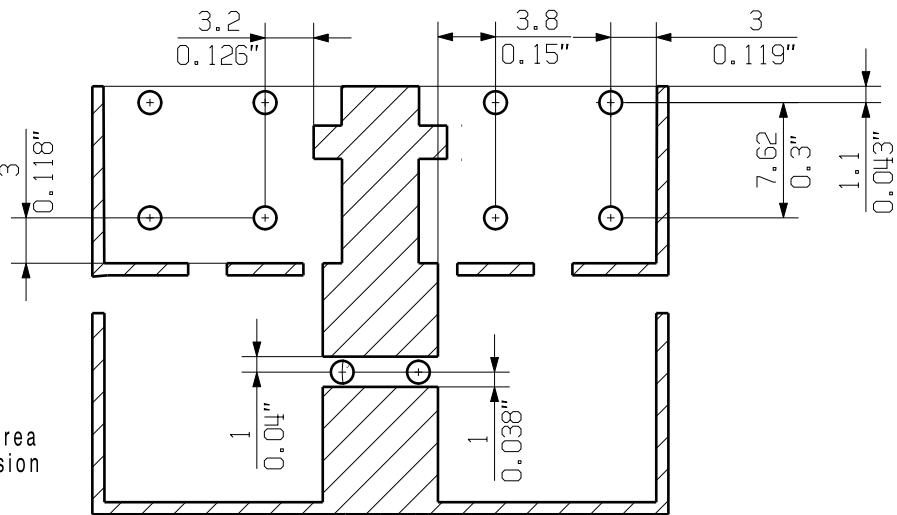
SV-SMT 7.62IT/04/90MF3
1:1



SV-SMT 7.62IT/04/90MF4
1:1



paste free area
max. dimension



For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components alone.
The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.
The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

GENERAL TOLERANCE:
DIN ISO 2768-m

EC00001677	Prim PLM Part No.: 114319	Prim ERP Part No.: 2454160000
First Issue Date 14.11.2017	Max. nos.	Modification
Scale: 2:1	Size: A3	Drawings Assembly
Drawn 14.05.2019 Helis, Maria	Date 19.06.2019 Lang, Thomas	Name Krug, Matthias
Product file: 7407 BLF 7.50HP		

SV 7.62IT/05/...M(S/L)F5	5	38.10	1.50	Pol	Pol	Pol	Pol	MF	PE				
SV 7.62IT/05/...M(S/L)F4				Pol	Pol	Pol	MF	Pol	Pol				
SV 7.62IT/05/...M(S/L)F3				Pol	Pol	MF	Pol	Pol	Pol				
SV 7.62IT/05/...M(S/L)F2				PE	MF	Pol	Pol	Pol	Pol				
SV 7.62IT/04/...M(S/L)F4	4	30.48	1.20	Pol	Pol	Pol	MF	PE					
SV 7.62IT/04/...M(S/L)F3				Pol	Pol	MF	Pol	Pol					
SV 7.62IT/04/...M(S/L)F2				PE	MF	Pol	Pol	Pol					
SV 7.62IT/03/...M(S/L)F3				Pol	Pol	MF	PE						
SV 7.62IT/03/...M(S/L)F2	3	22.86	0.90	PE	MF	Pol	Pol						
SV 7.62IT/02/...M(S/L)F2				Pol	MF	Pol							
description	no of poles	L1 [mm]	L1 [inch]	1	2	3	4	5	6	7	8	9	

66403	4
Sheet 07	of 16 sheets

SV-SMT 7.62IT/./MF...RL
STIFTELEISTE
MALE HEADER

Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com



Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.